

## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.

 001|  | PMP4482 | REU: A | SUN REU: Not In VersionControl |
| :--- | :--- | :--- | :--- | :--- | :--- |
|  | TID \#: PMP4482 |  |  |
| PLOT NAME $=$ Top Assembly Drawing | GENERATED $\quad: 3 / 29 / 2016 \quad 11: 35: 00 ~ A M ~$ | TEXAS INSTRUMENTS |  |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY UARIANT: 001

| PCB UIEWED FROM BOTTOM SIDE | BOARD \#: PMP4482 |  |  |
| :--- | :--- | :--- | :--- | :--- |
|  | TID \#: PMP4482 |  |  |
| PLOT NAME $=$ Bottom Assembly Drawing | GENERATED $\quad: 3,29 / 2016 \quad 11: 35: 01$ AM | TEXAS INSTRUMENTS |  |

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